Structure–property relationship of nanocrystalline tin dioxide thin films grown on (1012) sapphire

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This work demonstrates the correlation between the microstructure of nanocrystalline SnO2 thin films and their electrical transport properties and sensitivities to reducing gases. SnO2 thin films were deposited on the (1012) surface of α-Al2O3 (sapphire) using electron beam evaporation of a pure SnO2 ceramic source, followed by postdeposition annealing in synthetic air. SnO2 thin films with randomly oriented nanosized grains were obtained by annealing an amorphous SnO film deposited at room temperature. Films with nanosized SnO2 laminates were obtained by annealing epitaxial α-SnO films deposited at 600 °C. The laminates are oriented with their (101) planes parallel to the substrate surface and have a high density of coherent twin boundaries. Hall measurements indicate that the electron concentration of the film with laminate grains is much lower than for the film with random grains. It is proposed that the high density twin boundaries inside the laminates trap conducting electrons and significantly reduce the electron concentration. As a result, the sensitivity to reducing gases of the laminar film is higher than that of the corresponding film with randomly oriented SnO2 grains. It was also found that the grain size has strong effects on the sensitivity of SnO2 films. © 2001 American Institute of Physics.

I. INTRODUCTION

Owing to its high chemical and mechanical stability, SnO2 with the rutile type structure is extensively used in many applications such as solar cells, catalytic support material, transparent electrodes, and reducing gas sensors.1,2 SnO2 is widely used as a base material in gas alarm devices on domestic, commercial, and industrial premises due to its high sensitivity to small concentrations of gases (at ppm levels). In particular, SnO2 thin films have drawn much interest because of their potential application and integration with microsensor devices.3 Considerable attention has recently been focused on the development of solid state gas sensors based on thin films with a crystallite size smaller than the Debye length of the material, which show increased gas sensitivity and short response time.4,5 Taking into account its potential applications and importance for fundamental research as well as its simple structure, (rutile-type) SnO2 is an ideal model system for a systematic investigation of the microstructure effects on physical and chemical properties.

Solid state oxide semiconductor gas sensors undergo changes in their conductance due to changes in the conductance of the sensing element caused by the introduction of reducing gases. This effect is modulated by the introduction of reducing gases, which causes a change in the conductance of the sensing element accordingly. The characteristics of the surface barrier strongly depend upon the concentration and mobility of electrical carriers existing in the oxide thin films. Furthermore, the concentration and mobility of conducting electrons of oxide thin films strongly depend on the microstructure and crystal defects.9,10 For instance, grain boundaries in an n-type oxide semiconductor such as SnO2 can trap electrons and form back-to-back Schottky barriers. In a nanocrystalline thin film, the width of grain boundary barriers becomes comparable with the grain size, and the electrical transport phenomena can be quite different from those found in the bulk material. Furthermore, the electrical carrier concentration of oxide significantly depends on the stoichiometry of the material. The electrical carriers in SnO2 mainly originate from the oxygen vacancy donors, and the electrical properties are strongly controlled by chemical composition. Evidence also shows the strong dependence of optical properties on the microstructure, crystal defects, and chemical composition. The latter are strongly influenced by the processing conditions, which include deposition temperature, substrate structure, and postdeposition annealing.

It has been reported that deposition temperatures11 and annealing conditions12 have strong influences on the properties of SnO2 thin films synthesized by electron-beam evaporation followed by annealing in air. Reddy et al.13 found that films deposited at 25 and 350 °C are more suitable for sensor application compared to films deposited at intermediate temperatures and heat treated under identical conditions. Cho et al.14 reported the effects of annealing on the electrical...
properties of SnO$_2$ films prepared by electron beam evaporation. They found that the resistance of the SnO$_2$ thin films changed as a function of annealing temperature and reached the minimum at about 327 K. Most of the studies reported so far on tin oxide films fabricated by the electron-beam evaporation method focused on the influences of preparation conditions on electrical and optical properties of these films. However, there is little work on microstructure characterization, which is key to understanding the physical properties of the films. Hence a systematic study of the microstructure of SnO$_2$ thin films is necessary to obtain a fundamental understanding of the structure–property relationships.

In this article we report our studies on nanocrystalline SnO$_2$ thin films fabricated by electron beam evaporation of a pure SnO$_2$ ceramic source followed by postdeposition annealing in synthetic air. The microstructure of thin films with different deposition and annealing conditions were studied by x-ray diffraction (XRD), scanning electron microscopy (SEM), and transmission electron microscopy (TEM). Gas sensing performance and electrical properties were determined by electrical measurements using four point probes with several gaseous environments. The correlation between microstructure and properties has been established based on the experimental results.

II. EXPERIMENTAL METHODS

SnO$_2$ thin films were fabricated using electron beam evaporation of a SnO$_2$ ceramic source material. Disks of SnO$_2$ ceramic were prepared by sintering a high purity SnO$_2$ powder synthesized by the chemical coprecipitation method. The substrate material used in this study was single crystal $\alpha$-Al$_2$O$_3$ (sapphire) with a ($\overline{1}0\overline{1}2$) surface orientation (R-cut). The detailed description of the experimental procedure was given in previous works.$^{15,16}$

The microstructure of SnO$_2$ thin films was characterized by a combination of XRD and TEM. The surface morphology of the films was studied by SEM. Cross-section TEM specimens were prepared by a standard procedure, which includes mechanical grinding; polishing, precision dimpling, and ion milling. The final thinning of specimens was carried out on a Gatan precision ion polishing system (PIPS$^\text{TM}$, Model 691) using an accelerating voltage of 4.5 kV and an incident angle of 4°–6°.

The electrical properties of thin films were determined by Hall effect measurements in a 2.5 kG magnetic field, using the van der Pauw method. The thin film samples were loaded into a gas reaction chamber. The gas flow and composition were controlled by a mass-flow-controller (MFC) (MKS Instruments, Andover, MA). The gases used were prepurified N$_2$ (99.998%), extra dry O$_2$ (99.6%), and diluted high purity reducing gases (typically 5% gas balanced in N$_2$). Samples could be heated up to about 700 °C with the temperature fluctuation of about ±0.1 °C.

III. RESULTS

By the electron beam evaporation of a pure SnO$_2$ ceramic source amorphous films were obtained when deposited at temperatures below 300 °C whereas epitaxial $\alpha$-SnO films on the R-cut sapphire substrate were formed when deposited at 600 °C.$^{15}$ A postdeposition annealing in an oxygen atmosphere is necessary to transform the structure of the as-deposited films into the rutile-type SnO$_2$ phase, which is desired for gas sensor application. Our previous studies suggest that the SnO film will fully transform into the rutile SnO$_2$ phase by annealing at temperatures above 600 °C.$^{16}$ In this work, all as-deposited thin films were annealed at 700 °C for 2 or 150 h in flowing synthetic dry air (0.8 N$_2$/0.2 O$_2$). The deposition and annealing conditions for all samples studied are summarized in Table I. Samples A1-RT and A2-RT were cut from the same piece of an as-grown amorphous film (SnO) which was deposited at room temperature (~25 °C). Samples A1-600 and A2-600 were cut from an epitaxial $\alpha$-SnO film grown at 600 °C. All films were annealed under identical conditions except for the annealing time, as shown in Table I.

Figure 1 shows the result of XRD $\theta$–$2\theta$ scans for samples A1-RT and A1-600. All reflection peaks from these two samples are identified from either the rutile SnO$_2$ structure or the sapphire ($\alpha$-Al$_2$O$_3$) substrates. The XRD spectrum of sample A1-RT is similar to that of SnO$_2$ powder, which indicates that the film is polycrystalline, with ran-

<table>
<thead>
<tr>
<th>Sample</th>
<th>Deposition temperature (°C)</th>
<th>Annealing temperature (°C)</th>
<th>Annealing time (hours)</th>
</tr>
</thead>
<tbody>
<tr>
<td>A1-RT</td>
<td>−25</td>
<td>700</td>
<td>2</td>
</tr>
<tr>
<td>A2-RT</td>
<td>−25</td>
<td>700</td>
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<tr>
<td>A2-600</td>
<td>600</td>
<td>700</td>
<td>150</td>
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FIG. 1. X-ray diffraction patterns ($\theta$–$2\theta$) of SnO$_2$ thin films obtained by annealing (a) an amorphous SnO film (A1-RT) and (b) an epitaxial $\alpha$-SnO film (A1-600) in air at 700 °C for 2 h. The XRD pattern in (a) is similar to that of SnO$_2$ powder, which indicates that the film has randomly oriented grains. The pattern in (b) only shows 101 reflection of SnO$_2$. |
domly oriented grains. The XRD spectrum of sample A1-600 shows a reflection located at 33.9°, identified to be the \{101\} reflection of SnO$_2$. Other reflections correspond to the substrate. This result indicates that an out-of-plane texture exists in the A1-600 SnO$_2$ film. Moreover, the width of the diffraction peaks in sample A1-600 are much smaller than those in sample A1-RT, implying relatively large crystallites in the former film. The XRD results for sample A2-RT are similar to the one shown in Fig. 1.

Figure 2 shows SEM images of the surface morphology of the films deposited at room temperature and annealed for 2 and 150 h, A1-RT and A2-RT, respectively. Film A1-RT consists of very small grains with a mean size of ~15 nm. Some grains are connected to each other and form agglomerates. Film A2-RT has similar surface morphology as film A1-RT, however, its average grain size increases to 23 nm due to the long annealing time (150 h). Figure 3 shows SEM images of the surface morphology of the SnO$_2$ films (A1-600 and A2-600) deposited at 600 °C and annealed for 2 and 150 h, respectively. The grain sizes in both films are distributed in a wide range between 20 and 300 nm and the average size is about 80 nm. Through our SEM observation, pores with a size of ~30 nm were found in all films.

Cross-section TEM investigations were carried out for samples A1-RT and A1-600. Figure 4(a) shows a cross-section micrograph taken from A1-RT which was obtained by annealing an amorphous tin oxide film at 700 °C for 2 h. The film consists of both small, randomly shaped grains and columnar grains as seen in the middle of Fig. 4(a). The mean grain size in this film is ~15 nm, in agreement with the SEM measurements. Figure 4(b) is a cross-section TEM micrograph showing the microstructure of film A1-600, obtained by annealing the epitaxial SnO film at 700 °C for 2 h. It is clearly seen in this image that the film consists of laminar grains. The laminas have an average thickness of ~20 nm. The grain size in lateral direction is ~100 nm. TEM studies were also conducted on film A2-600 that was obtained by annealing the same epitaxial SnO film at the same temperature as A1-600, but for 150 h. It was found that the laminas in this film have a crystallite dimension along the lateral direction similar to that of A1-600, however, it has a larger average thickness of 28 nm, compared to 20 nm in A1-600. This indicates that long time annealing results in the grain growth along the direction perpendicular to the laminar plane. According to TEM studies, we found that both A1-600 and A2-600 films have a relatively low density with a mean pore size of ~30 nm. The existence of pores is probably due to the density difference between the as-grown epitaxial \(\alpha\)-SnO films and the final SnO$_2$ films. The density of \(\alpha\)-SnO is 6.45 g/cm$^3$, while the rutile SnO$_2$ phase has a density of 6.95 g/cm$^3$. Thus annealing causes a 7% volume shrinkage, which may result in the formation of pores in the film. Moreover, the three-dimensional growth of the rutile SnO$_2$ grains will also lead to a rough surface and cause the formation of pores in the film. Another feature of the microstructure is that the SnO$_2$ films (A1-600 and A2-600) obtained by annealing the epitaxial \(\alpha\)-SnO films consist of a high density of crystallographic shear planes and coherent \(\{101\}\) twin boundaries parallel to the film/substrate interface. A typical example of such defect structures of a SnO$_2$ laminate in A1-600 is shown in Fig. 5 of the previous paper. The formation of the twin boundaries is due to the phase
transformation from the epitaxial $\alpha$-SnO to the rutile SnO$_2$ phase during annealing in air. The detailed studies of the formation mechanisms are described in previous work.

The significant difference found between the microstructure (surface morphology, grain size, and shape) of the SnO$_2$ thin films can influence the electrical transport properties of these films. Figure 5 shows the resistivity as a function of inverse temperature for A1-RT and A1-600. Figure 5(a) was obtained from A1-RT, whereas Fig. 5(b) was measured from A1-600. The activation energy determined from the slope of the resistivity–temperature curve is 0.063 eV for A1-RT and 0.158 eV for A1-600. These studies show that sample A1-600 has higher resistivity and higher activation energy than sample A1-RT. Furthermore, Hall measurements revealed that the electrical transport properties of these samples are different. The electron concentration, Hall mobility, and electrical resistivity for each film, measured at room temperature, are summarized in Table II. The Hall mobility of conducting electrons is similar for both films. However, the conducting electron concentration of the sample A1-RT is one order of magnitude higher than that of A1-600. This is consistent with the high activation energy (0.158 eV) of electrons and lower conductivity of sample A1-600. We would like to point out that the observed increase in resistivity with increasing temperature at about 350 °C is due to a decrease in electron mobility (thermal scattering) at high temperatures. In addition, at these high temperatures oxygen reacts with the film and reduces the number of oxygen vacancies, thus decreasing the number of electrical carriers.

We have also evaluated the sensitivity of SnO$_2$ films to reducing gases, which is defined as the resistance ratio $S = R_a/R_g$, where $R_a$ and $R_g$ are the resistance measured in synthesized air and reducing gaseous environments, respectively. It was found that the SnO$_2$ films studied in this work have the highest sensitivity when operated at 350 °C. Figure 6 shows the response of A1-RT and A2-RT to H$_2$ at 350 °C. The film annealed for 2 h (A1-RT) has higher sensitivity than the film which was annealed for 150 h (A2-RT). This means that SnO$_2$ film with smaller grain size has higher sensitivity. Figure 7 shows the response of A1-RT and A1-600 to H$_2$ at 350 °C. Figure 7 shows that the film A1-600 has higher sensitivity to H$_2$ than A1-RT. These results indicate that the SnO$_2$ film that consists of nanosized laminar grains with the (101) texture has better sensing performance to H$_2$ than those obtained by annealing amorphous SnO film under the same annealing conditions, although the latter one has smaller grain size than the former one.

**IV. DISCUSSION**

Tin dioxide is a wide band-gap $n$-type semiconductor. Its electrical transport behavior is controlled by the stoichiometry...
The depth of the electron depletion layer is characterized by the Debye length $L_D$, which is determined by the bulk donor level electron concentration in the material through the following equation:

$$L_D = \sqrt{\frac{\varepsilon_s kT}{q^2 N_D}},$$  \hspace{1cm} (1)

where $\varepsilon_s$ is semiconductor permittivity, $k$ is the Boltzmann constant, $T$ is the temperature in Kelvin, $q$ is the electron charge, and $N_D$ is the donor concentration. The depletion layer needs to extend deeper in a material with low donor density in bulk, so that it could have enough electrons to ionize surface oxygen. The sensitivity ($R_s/R_d$) is determined by the change of conductivity on exposure to reducing gases. The change in conductivity by the introduction of a reducing gas is greater for a film with lower electron concentration. Thus the more the film is depleted and also the closer $L_D$ is to the characteristic length of the system (thickness or grain size), the higher the gas sensitivity. Thus for a given electron concentration, an oxide film consisting of smaller grains has a higher sensitivity. This explains the difference in gas sensing performance of two SnO$_2$ films (A1-RT and A2-RT), which have similar electrical properties (electron concentration and mobility) and microstructure except for the difference in grain size. The film A1-RT with a mean grain size of 15 nm shows a slightly higher sensitivity to H$_2$ than the film A2-RT which has a mean grain size of 23 nm.

Films with very different morphology, growth mechanism, and orientation also show very different electrical properties. Our experimental results showed that the electrical conductivity of the film A1-RT is higher than that of A1-600 (Fig. 5). The main differences in the microstructures between these two films are the grain size and grain orientation, as shown in Fig. 4. SEM studies (Figs. 2 and 3) showed that the film deposited at 600 °C has a higher porosity than the one deposited at room temperature. The presence of pores in the film can create a discontinuous path for electron conduction and leads to the existence of neck conduction. This type of feature is known to decrease substantially the conductivity of the film by creating very inhomogeneous conduction (low resistance percolation paths) which is very difficult to measure using the Hall effect.

Hall measurements revealed that the electron carrier concentration in the film with laminar microstructure (A1-600) is one magnitude lower than that in the film with random fine grain microstructure (A1-RT). On the other hand, the electron mobility is slightly greater for the film with a laminar structure. The mobility for polycrystalline films ($\mu$), with a mean free path greater than the grain size, has been modeled as:

$$\mu = \mu_0 \frac{[l_1/l_2]^2 C \exp(-\Delta E/kT)}{l_1/l_2},$$  \hspace{1cm} (2)

where $\mu_0$ is the single crystal mobility, $l_1$ is the grain size, $l_2$ the boundary width, $C$ a constant for a given material, and $\Delta E$ the grain boundary energy barrier. From the equation it can be observed that a greater grain size or smaller grain boundary width will result in a higher mobility. Figures 4(a) and 4(b) show that the laminar film has a greater grain size than the random film. It also shows that there are less grain boundary barriers parallel to electron conduction than in the random film. These two facts explain the greater mobility of the laminar film. However, this does not explain the lower electron concentration in the laminar film. Thus other mechanisms should be responsible for this difference. As shown in Fig. 5 of the previous article the films grown from epitaxial SnO (grown at 600 °C) have a high density of defects. The most abundant defects in the system are coherent (101) twin boundaries. These boundaries, due to their special crystallographic characteristics, do not contribute greatly to electron scattering. However, these twin boundaries cause the interruption of crystal lattice and trap conducting electrons, which creates an electrical barrier at the boundary. As a result, the existence of a large of number of twin boundaries can greatly lower the free electron concentration in the film and decrease the film conductivity, as shown in Fig. 5. Since films with laminar microstructure have low electron concentration, the depletion region is wider in these films and their sensitivity is higher than for the random grained films, as shown in Fig. 7.

The sensitivity can also be influenced by the grain orientation. Rohrer and coworkers investigated the orientation dependence of photochemical reactions on a rutile type...
TiO$_2$ surface. They found that the most reactive surfaces in rutile TiO$_2$ are near the $\{101\}$ orientation because of the four-coordinate Ti on the $\{101\}$ surface. It was also reported that surfaces containing four-coordinate Ti had an increased selectivity for certain partial oxidation reactions. According to these results and the fact that SnO$_2$ has the same rutile structure as TiO$_2$, high sensitivity may be expected for the SnO$_2$ film which consists of $\{101\}$ oriented grains. This is consistent with our experimental results shown in Fig. 7. Also, it is possible that the $\{101\}$ oriented laminar grains chemisorbed more oxygen than the random grains during annealing, due to their higher reactivity. This chemisorbed oxygen (from annealing) would stay on the surface after annealing (strong chemical bond) and trap conduction electrons decreasing the conductivity of the laminar film with respect to the random film.

V. CONCLUSION

In conclusion, it has been demonstrated that the electrical transport properties and the sensitivities to reducing gases of SnO$_2$ thin films depend strongly upon the feature of microstructure and crystal defects. By controlling the deposition temperature during electron beam evaporation, nanocrystalline SnO$_2$ thin films with either randomly oriented or laminar grains were produced after annealing. The film with laminar grains showed lower electron concentration and higher sensitivity to reducing gases. This was attributed to the great number of twin boundaries within the laminar grains, which acted as free electron trapping sites. For films with the same grain morphology, the grain size can be controlled by annealing temperature and time. The smaller the grain size the higher the sensitivity to reducing gases, due to an increased fraction of electron depletion in the smaller grains.

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15. L. Fu and X. Q. Pan, J. Electroceram. (submitted).